

## TC74VHC238F, TC74VHC238FN, TC74VHC238FT, TC74VHC238FK

### 3-to-8 Line Decoder

The TC74VHC238 is an advanced high speed CMOS 3-to-8 DECODER fabricated with silicon gate C<sup>2</sup>MOS technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

When the device is enabled, 3 Binary Select inputs (A, B and C) determine which one of the outputs (Y0-Y7) will go High.

When enable input G1 is held low or either  $\overline{G2A}$  or  $\overline{G2B}$  is held high, decoding function is inhibited and all outputs go Low.

G1,  $\overline{G2A}$ , and  $\overline{G2B}$  inputs are provided to ease cascade connection and for use as an address decoder for memory systems.

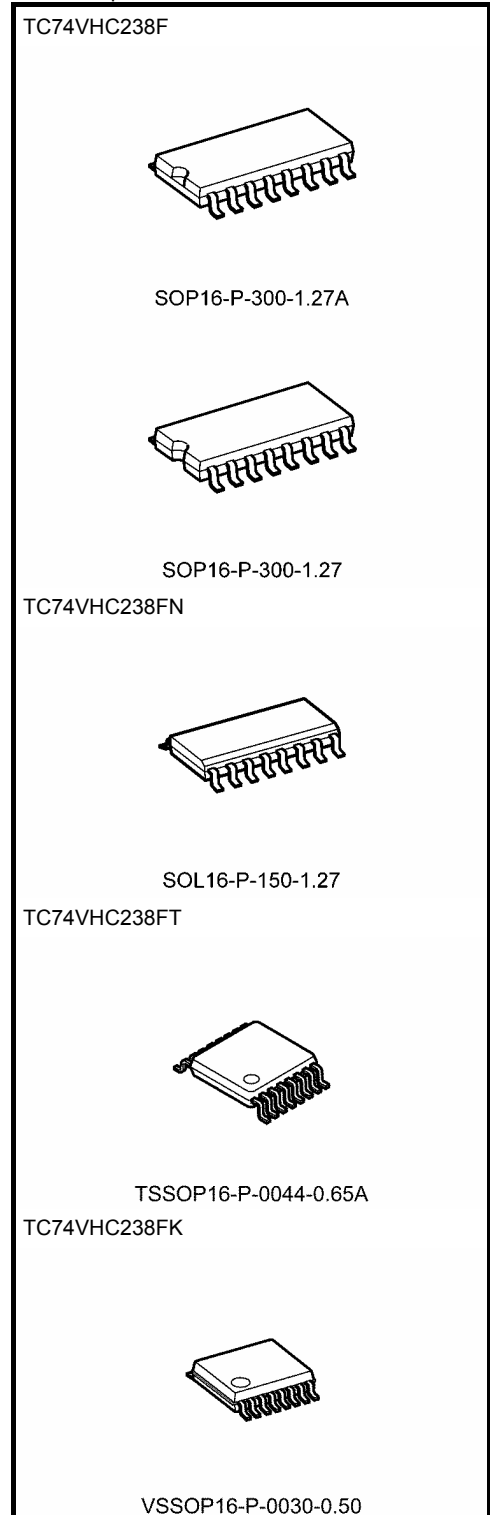
An input protection circuit ensures that 0 to 5.5 V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5 to 3 V systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

### Features

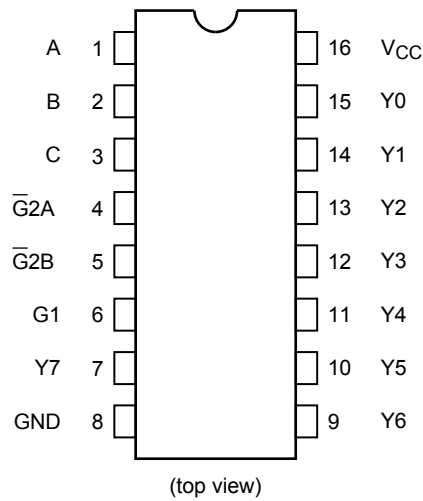
- High speed:  $t_{pd} = 5.5$  ns (typ.) at  $V_{CC} = 5$  V
- Low power dissipation:  $I_{CC} = 4$   $\mu$ A (max) at  $T_a = 25^\circ$ C
- High noise immunity:  $V_{NIH} = V_{NIL} = 28\%$   $V_{CC}$  (min)
- Power down protection is provided on all inputs.
- Balanced propagation delays:  $t_{pLH} \approx t_{pHL}$
- Wide operating voltage range:  $V_{CC} (opr) = 2$  to 5.5 V
- Pin and function compatible with 74ALS238

Weight	
SOP16-P-300-1.27A	: 0.18 g (typ.)
SOP16-P-300-1.27	: 0.18 g (typ.)
SOL16-P-150-1.27	: 0.13 g (typ.)
TSSOP16-P-0044-0.65A	: 0.06 g (typ.)
VSSOP16-P-0030-0.50	: 0.02 g (typ.)

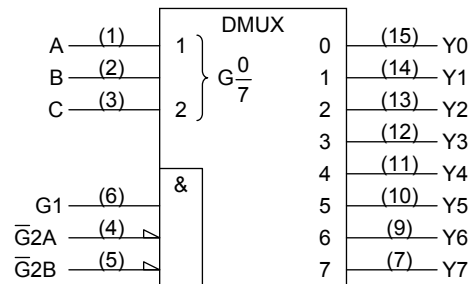
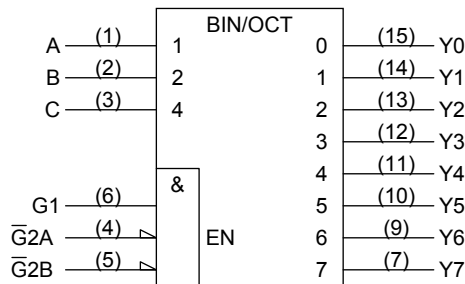
Note: xxxFN (JEDEC SOP) is not available in Japan.



## Pin Assignment



## IEC Logic Symbol

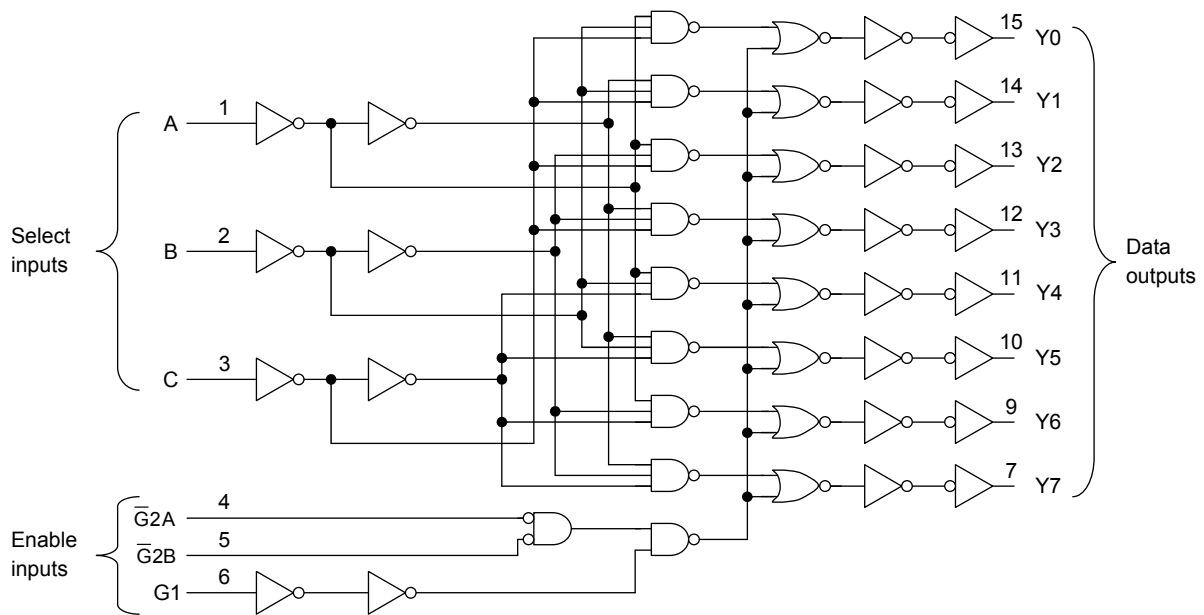


## Truth Table

Inputs						Outputs								Selected Output
Enable			Select			Y0	Y1	Y2	Y3	Y4	Y5	Y6	Y7	
G1	$\overline{G2A}$	$\overline{G2B}$	C	B	A									
L	X	X	X	X	X	L	L	L	L	L	L	L	L	None
X	H	X	X	X	X	L	L	L	L	L	L	L	L	None
X	X	H	X	X	X	L	L	L	L	L	L	L	L	None
H	L	L	L	L	L	H	L	L	L	L	L	L	L	Y0
H	L	L	L	L	H	L	H	L	L	L	L	L	L	Y1
H	L	L	L	H	L	L	L	H	L	L	L	L	L	Y2
H	L	L	L	H	H	L	L	L	H	L	L	L	L	Y3
H	L	L	H	L	L	L	L	L	L	H	L	L	L	Y4
H	L	L	H	L	H	L	L	L	L	L	H	L	L	Y5
H	L	L	H	H	L	L	L	L	L	L	L	H	L	Y6
H	L	L	H	H	H	L	L	L	L	L	L	L	H	Y7

X: Don't care

## Logic Diagram



## Absolute Maximum Ratings (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage range	$V_{CC}$	-0.5 to 7.0	V
DC input voltage	$V_{IN}$	-0.5 to 7.0	V
DC output voltage	$V_{OUT}$	-0.5 to $V_{CC} + 0.5$	V
Input diode current	$I_{IK}$	-20	mA
Output diode current	$I_{OK}$	$\pm 20$	mA
DC output current	$I_{OUT}$	$\pm 25$	mA
DC $V_{CC}$ /ground current	$I_{CC}$	$\pm 75$	mA
Power dissipation	$P_D$	180	mW
Storage temperature	$T_{stg}$	-65 to 150	$^{\circ}C$

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

## Operating Range (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	$V_{CC}$	2.0 to 5.5	V
Input voltage	$V_{IN}$	0 to 5.5	V
Output voltage	$V_{OUT}$	0 to $V_{CC}$	V
Operating temperature	$T_{opr}$	-40 to 85	$^{\circ}C$
Input rise and fall time	dt/dv	0 to 100 ( $V_{CC} = 3.3 \pm 0.3$ V) 0 to 20 ( $V_{CC} = 5 \pm 0.5$ V)	ns/V

Note: The operating range must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either  $V_{CC}$  or GND.

## Electrical Characteristics

### DC Characteristics

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit	
				V <sub>CC</sub> (V)	Min	Typ.	Max	Min		Max
High-level input voltage	V <sub>IH</sub>	—		2.0 3.0 to 5.5	1.50 V <sub>CC</sub> × 0.7	— —	— —	1.50 V <sub>CC</sub> × 0.7	— —	V
Low-level input voltage	V <sub>IL</sub>	—		2.0 3.0 to 5.5	— —	— —	0.50 V <sub>CC</sub> × 0.3	— —	0.50 V <sub>CC</sub> × 0.3	V
High-level output voltage	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -50 μA	2.0 3.0 4.5	1.9 2.9 4.4	2.0 3.0 4.5	— — —	1.9 2.9 4.4	— — —	V
			I <sub>OH</sub> = -4 mA	3.0	2.58	—	—	2.48	—	
			I <sub>OH</sub> = -8 mA	4.5	3.94	—	—	3.80	—	
Low-level output voltage	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 50 μA	2.0 3.0 4.5	— — —	0.0 0.0 0.0	0.1 0.1 0.1	— — —	0.1 0.1 0.1	V
			I <sub>OL</sub> = 4 mA	3.0	—	—	0.36	—	0.44	
			I <sub>OL</sub> = 8 mA	4.5	—	—	0.36	—	0.44	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND		0 to 5.5	—	—	±0.1	—	±1.0	μA
Quiescent supply current	I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	—	—	4.0	—	40.0	μA

## AC Characteristics (input: $t_r = t_f = 3$ ns)

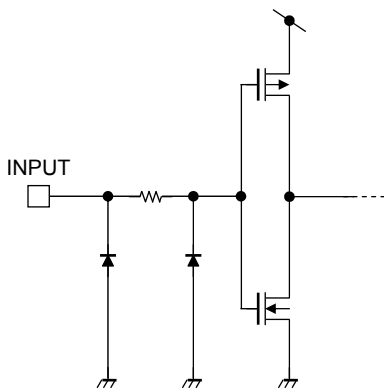
Characteristics	Symbol	Test Condition	Ta = 25°C			Ta = -40 to 85°C		Unit		
			V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Typ.	Max		Min	Max
Propagation delay time (A, B, C-Y)	t <sub>pLH</sub>	—	3.3 ± 0.3	15	—	8.0	12.3	1.0	14.5	ns
				50	—	10.5	15.8	1.0	18.0	
	5.0 ± 0.5		15	—	5.5	8.1	1.0	9.5		
			50	—	7.0	10.1	1.0	11.5		
Propagation delay time (G1-Y)	t <sub>pLH</sub>	—	3.3 ± 0.3	15	—	8.1	12.8	1.0	15.0	ns
				50	—	10.6	16.3	1.0	18.5	
	5.0 ± 0.5		15	—	5.4	8.1	1.0	9.5		
			50	—	6.9	10.1	1.0	11.5		
Propagation delay time ( $\bar{G}2$ -Y)	t <sub>pLH</sub>	—	3.3 ± 0.3	15	—	8.1	12.3	1.0	14.5	ns
				50	—	10.6	15.8	1.0	18.0	
	5.0 ± 0.5		15	—	5.7	8.1	1.0	9.5		
			50	—	7.2	10.1	1.0	11.5		
Input capacitance	C <sub>IN</sub>	—	—	4	—	—	10	pF		
Power dissipation capacitance	C <sub>PD</sub>	(Note)	—	37	—	—	—	pF		

Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

$$I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$$

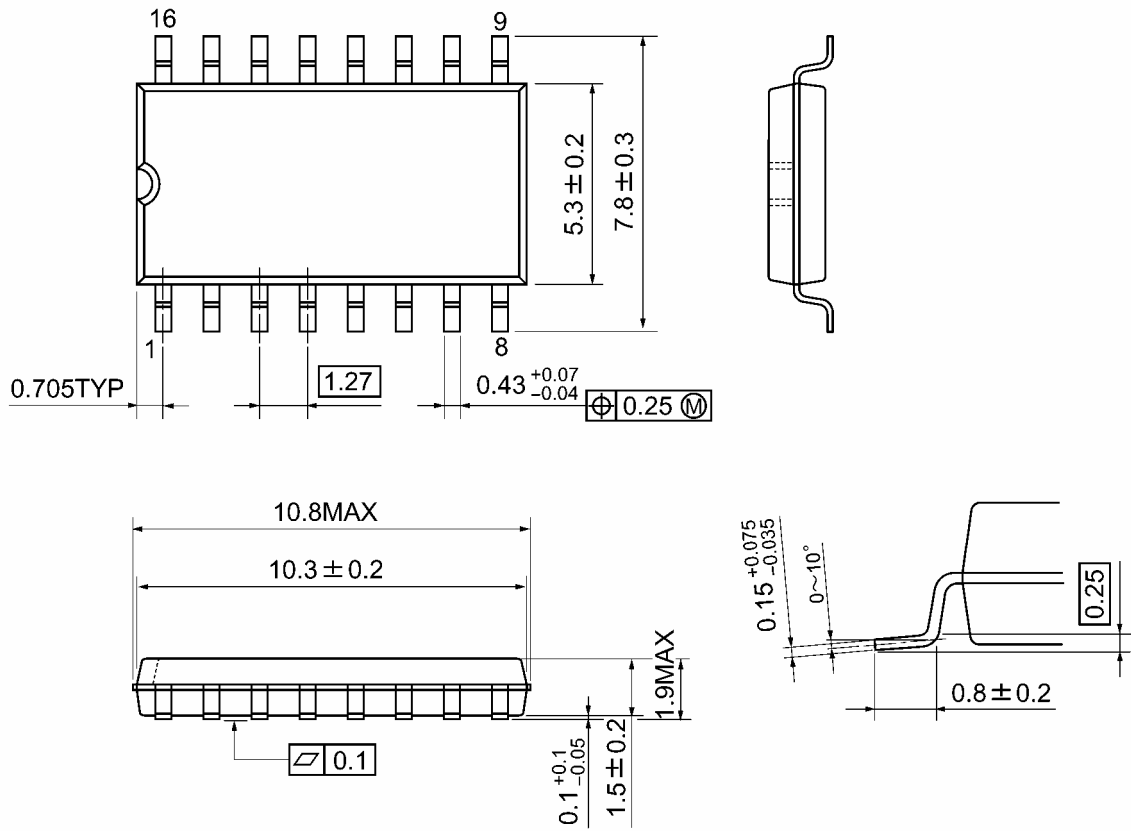
## Input Equivalent Circuit



## Package Dimensions

SOP16-P-300-1.27A

Unit: mm

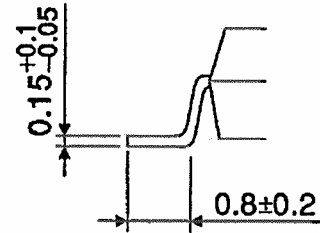
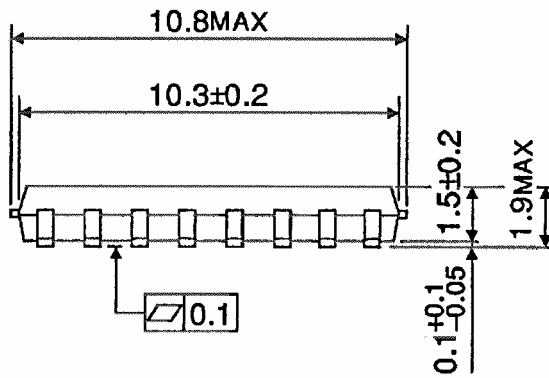
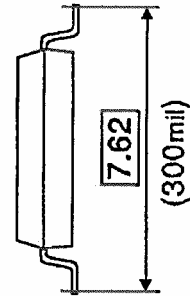
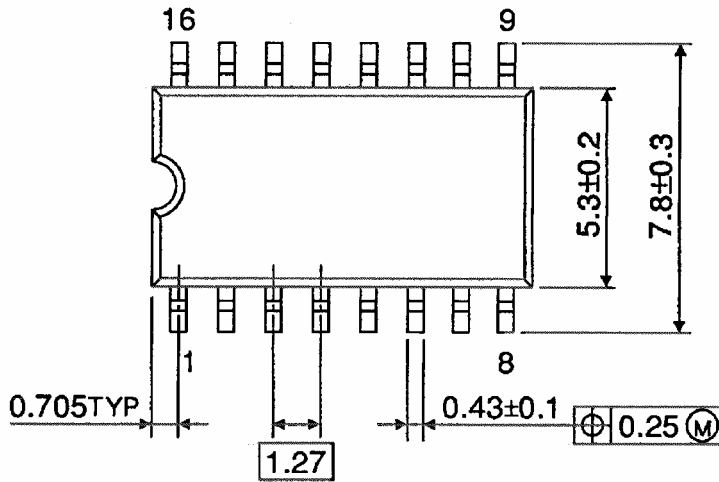


Weight: 0.18 g (typ.)

**Package Dimensions**

SOP16-P-300-1.27

Unit : mm

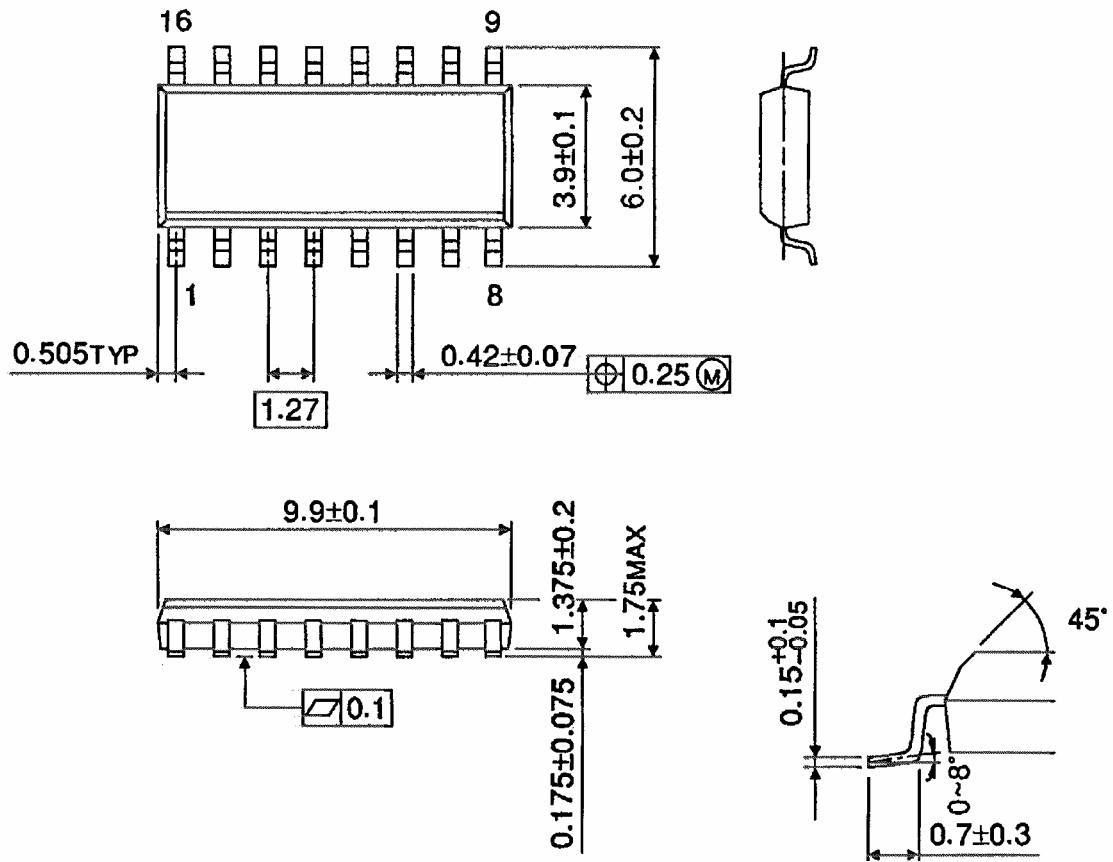


Weight: 0.18 g (typ.)

## Package Dimensions (Note)

SOL16-P-150-1.27

Unit : mm



Note: This package is not available in Japan.

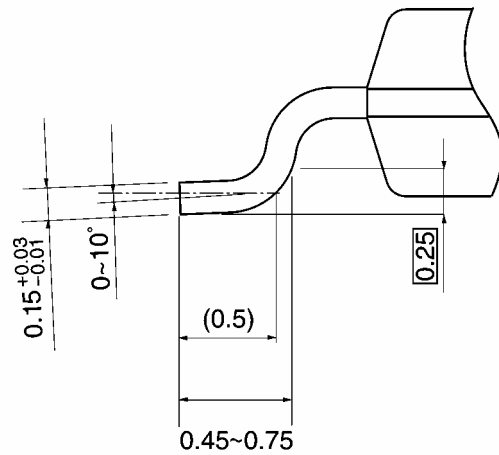
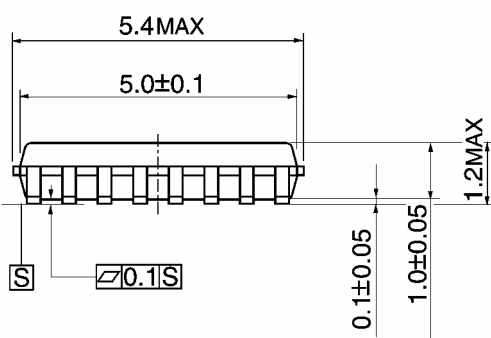
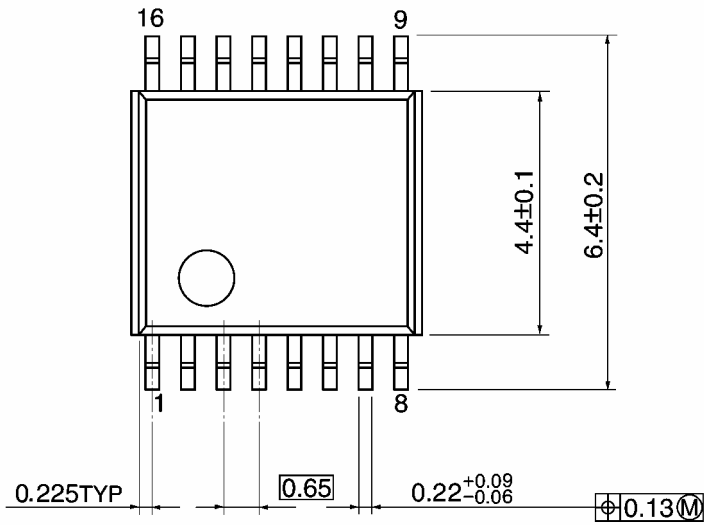
Weight: 0.13 g (typ.)



## Package Dimensions

TSSOP16-P-0044-0.65A

Unit: mm

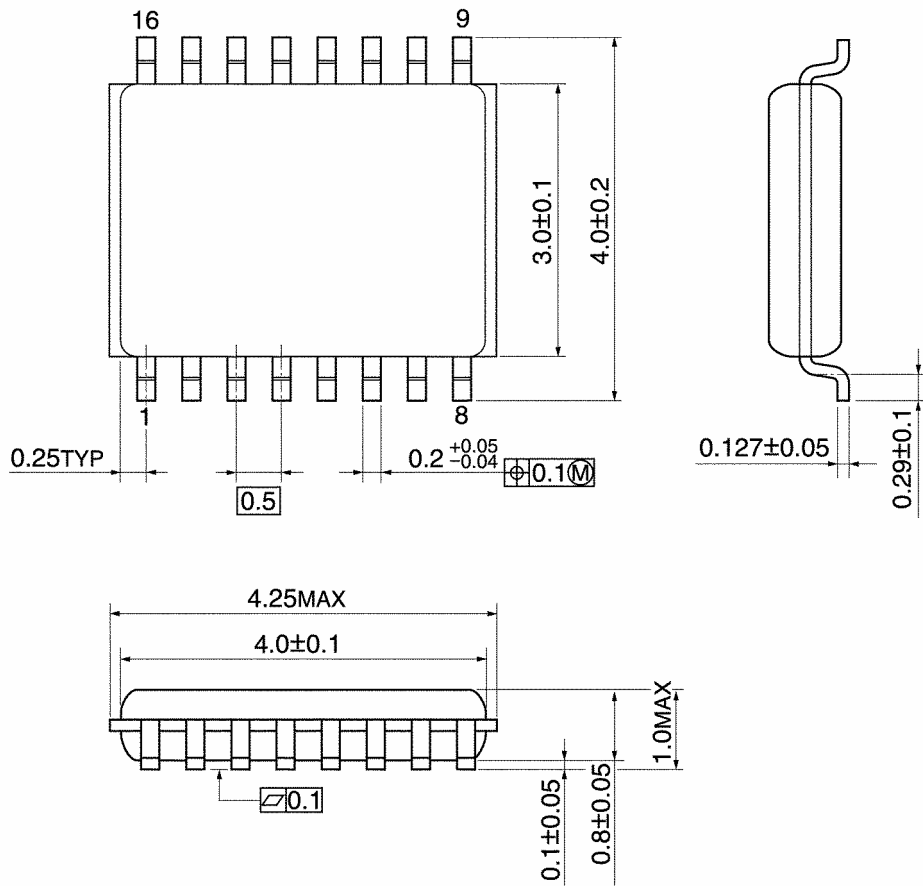


Weight: 0.06 g (typ.)

## Package Dimensions

VSSOP16-P-0030-0.50

Unit: mm



Weight: 0.02 g (typ.)

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